# Ultra-low-power consumption with the MSP430FR57xx family featuring FRAM





MSP430<sup>™</sup> MCUs with Ferroelectric Random Access Memory (FRAM) offer even lower power consumption. With an active power mode of 100μA/MHz, these microcontrollers are truly industry leading. For applications that require continuous data logging, the low power consumption of these devices is unbeatable at 200 to 250 times less than typical flash memory based microcontrollers. While writing to memory, the MSP430FR57xx only needs 2.0V of current with no charge pump or boost whereas most Flash memory MCUs will need 12V to 15V of current to write.

#### FRAM microcontrollers

Performance and capabilities of today's embedded controllers are limited by the type of memory technology used. The MSP430FR57xx family with FRAM introduces the market to a new generation of superior non-volatile memory devices. This unified memory makes the MSP430FR57xx microcontroller very flexible. For example, you can dynamically partition the device memory into code space or data space, as needed. Again, this brings incredible flexibility to software designers, product manufacturers and

others offering a lower cost of ownership. FRAM is at the forefront of these 'next generation' memory technologies; it is the most proven and mature, having been used for the past several years in diverse applications from EEPROM or battery backed SRAM replacement devices to automotive applications. Texas Instruments is continuing our tradition of innovation by delivering embedded FRAM products that bring real, tangible value to our customers and partners.

# MSP430FR57xx Microcontroller Comparison

	MSP430FR57xx	Flash microcontroller
Max. data write throughput (kBps)	1,400	13
Power consumption at max. throughput (µA)	720	2,200
Power consumption at 13 kBps throughput (µA)	9	2,200
Write endurance cycles	>100 trillion	100 to 100,000

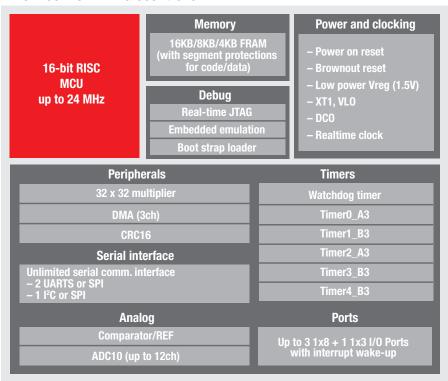
For more information, visit ti.com/fram

## Key features

- Non-volatile memory data state is retained even when power is turned off
- Fast write speeds current implementations are at less than 50ns up to 100x faster than Flash or EEPROM technologies
- High endurance over 100 trillion write cycles
- Very low memory access power requirements – 2.0v read/write compared to >10-14v write for Flash and EEPROM
- Enhanced data reliability inherent write guarantee during a write cycle even in case of power loss
- Resistant to gamma radiation

Device	FRAM (KB)	SRAM (KB)	System Clock (MHz)	ADC10_B	Comp_D	Timer_A (1)	Timer_B (2)	eUSCI		Package Type			
								Channel A: UART/IrD A/SP	Channel B: SPI/ I <sup>2</sup> C	24 QFN	38 TSSOP	40 QFN	28 TSSOP
MSP430FR5739	16	1	24	у	16 ch.	3, 3	3, 3, 3	2	1		DA	RHA	
MSP430FR5738	16	1	24	у	10 ch.	3, 3	3	1	1	RGE			PW
MSP430FR5737	16	1	24	-	16 ch.	3, 3	3, 3, 3	2	1		DA	RHA	
MSP430FR5736	16	1	24	-	10 ch.	3, 3	3	1	1	RGE			PW
MSP430FR5735	8	1	24	у	16 ch.	3, 3	3, 3, 3	2	1		DA	RHA	
MSP430FR5734	8	1	24	у	10 ch.	3, 3	3	1	1	RGE			PW
MSP430FR5733	8	1	24	-	16 ch.	3, 3	3, 3, 3	2	1		DA	RHA	
MSP430FR5732	8	1	24	-	10 ch.	3, 3	3	1	1	RGE			PW
MSP430FR5731	4	0.512	24	у	16 ch.	3, 3	3, 3, 3	2	1		DA	RHA	
MSP430FR5730	4	0.512	24	у	10 ch.	3, 3	3	1	1	RGE			PW
MSP430FR5729	16	1	8	у	16 ch.	3, 3	3, 3, 3	2	1		DA	RHA	
MSP430FR5728	16	1	8	у	10 ch.	3, 3	3	1	1	RGE			PW
MSP430FR5727	16	1	8	-	16 ch.	3, 3	3, 3, 3	2	1		DA	RHA	
MSP430FR5726	16	1	8	-	10 ch.	3, 3	3	1	1	RGE			PW
MSP430FR5725	8	1	8	у	16 ch.	3, 3	3, 3, 3	2	1		DA	RHA	
MSP430FR5724	8	1	8	у	10 ch.	3, 3	3	1	1	RGE			PW
MSP430FR5723	8	1	8	-	16 ch.	3, 3	3, 3, 3	2	1		DA	RHA	
MSP430FR5722	8	1	8	-	10 ch.	3, 3	3	1	1	RGE			PW
MSP430FR5721	4	0.512	8	у	16 ch.	3, 3	3, 3, 3	2	1		DA	RHA	
MSP430FR5720	4	0.512	8	у	10 ch.	3, 3	3	1	1	RGE			PW

#### MSP430FR57xx Microcontroller



# **Tools and support**

Get started enjoying the benefits of the new MSP430FR57xx microcontrollers with these easy to use tools:

#### Software:

CCS v4.2.3

IAR-EW430 v5.20.x

#### Hardware:

MSP-EXP430FR5739 experimenters board MSP-TS430RHA40A socketed target board

www.ti.com/fram

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